506926870 10/18/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6973706

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHI-HUI LAI	10/18/2021
SHU-RONG CHUN	10/18/2021
KUO-LUNG PAN	10/18/2021
TING HAO KUO	10/18/2021
HAO-YI TSAI	10/18/2021
CHUNG-SHI LIU	10/18/2021
CHEN-HUA YU	10/18/2021
YU-CHIA LAI	10/18/2021

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16589758

CORRESPONDENCE DATA

Fax Number: (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 972-732-1001

Email: docketing@slatermatsil.com

Correspondent Name: SLATER MATSIL, LLP

Address Line 1: 17950 PRESTON RD., SUITE 1000

Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	TSMP20183833US01
NAME OF SUBMITTER:	JENNIFER RUBIO
SIGNATURE:	/Jennifer Rubio/

PATENT 506926870 REEL: 057819 FRAME: 0187

DATE SIGNED:	10/18/2021
Total Attachments: 5	
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PATENT REEL: 057819 FRAME: 0188

Docket Number: TSMP20183833US01

DECLARATION AND ASSIGNMENT

Title of Invention: Integrated Circuit Package and Method

As a below named inventor, or one of the below named joint inventors, I hereby declare that:

This declaration and assignment is directed to the application attached hereto. If the application is not attached hereto, the application is as identified by the attorney docket number as set forth above and/or the following:

United States Application No. or PCT International Application No.: ____16/589,758___, filed on ___10/1/2019__.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56.

All statements made of my own knowledge are true and all statements made on information and belief are believed to be true.

I hereby acknowledge that any willful false statement made in this declaration may jeopardize the validity of the application or any patent issuing thereon and is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

The above-identified invention shall henceforth be referred to herein as the "INVENTION" and the above-identified application shall henceforth be referred to herein as the "APPLICATION."

Taiwan Semiconductor Manufacturing Company, Ltd., a corportion organized and existing under the laws of Taiwan, with its principal office at 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, 300-78, and its heirs, successors, legal representatives and assigns shall henceforth be referred to collectively herein as ASSIGNEE.

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have assigned and do hereby assign to ASSIGNEE, its successors and assigns, my entire right, title and interest in and to said INVENTION and in and to said APPLICATION and all patents which may be granted therefor, and all future non-provisional applications including, but not limited to, divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said INVENTION, or patents resulting therefrom, insofar as my interest is concerned, to ASSIGNEE, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

Additionally, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have also assigned and hereby assign to ASSIGNEE, its successors and assigns, all of my rights to the INVENTION disclosed in said APPLICATION, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and I further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

PATENT REEL: 057819 FRAME: 0189

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I hereby further agree that I will communicate to ASSIGNEE, or to its successors, assigns, and legal representatives, any facts known to me respecting said INVENTION or the file history thereof, and at the expense of ASSIGNEE, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid ASSIGNEE, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

I hereby grant the afformey of record the power to insert on this document any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year.

NAME OF INVENTOR (Full Legal Name) : Chi-Hui Lai	
45.6 A A A A A A A A A A A A A A A A A A A	
Signature: <u>CAS-HAR LAR</u>	Date: 202 / 10 / 18
NAME OF INVENTOR (Full Legal Name) : Shu-Rong Chun	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Kuo-Lung Pan	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name): Ting Hao Kuo	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name): Hao-Yi Tsai	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name): Chung-Shi Liu	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Chen-Hua Yu	
· · · · · · · · · · · · · · · · · · ·	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Yu-Chia Lai	
Signature:	Date:

Docket Number:	TEMPORT	2020112001
DESCRIPTION OF THE PROPERTY OF	5 A21899 CALL 2	GUGGGGGGG

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NAME OF INVENTOR (Full Legal Name) : Chi-Hui Lai Signature:	·
NAME OF INVENTOR (Full Legal Name) : Shu-Rong Chun	alan kulolik (h. 1949) alam mendi hiri kebilik di la Kamanan mendikan pamanan mendikan kebilik di kembalan di k
Simplifier 940-Roye Chan	
Signature: /// ''\ \ \ ////	Date: 18/18/2021
NAME OF INVENTOR (Full Legal Name) . Kuo-Lung Pan	an kan manan di manggapan ang matalayan kasan di
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Signature: KWO-Long Porn	Date:
NAME OF INVENTOR (Full Legal Name): Ting Hao Kuo	etra esa e 1,00 an era esa defenta 1,000 metro.
	eskeletik ettet jassi 1. mare hav järekvälle stem teleti
Signature:	Date
NAME OF INVENTOR (Full Legal Name) : Hao-Yi Tsai	
Signature: Hap Yr Tseci	Date. 201, 10, 19.
NAME OF INVENTOR (Full Legal Name) : Chung-Shi Liu	
Signature: (MMM-/ 1) /2M	Date: (5/) (7/)
Container .	Date:
NAME OF INVENTOR (Full Legial Name) : Chen-Hua Yu	an agan bar till ogginden all starta skrivateter. Filosofijaren i samfarta meggel yelek digilaranen.
	aparas com processo processos
Signature:	wa:e:
NAME OF INVENTOR (Full Legal Name): Yu-Chia Lai	999gan, denggan ya depagasakan 1867 (1867-1867). Banya Hari ya mpagasanan ganundan bili ukacan maturi 1867 (18
Signature: Yu - Chia Lai	Date: (1/3/30)

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NAME OF INVENTOR (Full Legal Name) : Chi-Hui Lai	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Shu-Rong Chun	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Kuo-Lung Pan	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name):Ting Hac Kuc Signature: ブルタ <u>ける</u> o <u></u>	Date: <u>ンの</u> ソーパリタ
NAME OF INVENTOR (Full Legal Name): Hao-Yi Tsai	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) : Chung-Shi Liu	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name): Chen-Hua Yu	
Signature:	Date:
NAME OF INVENTOR (Full Legal Name) ; Yu-Chia Lai	
Signature:	Date:

Docket Number: TSMP20183833US01

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IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year.

Severed 2021/20/15 10:18:40

NAME OF INVENTOR (Full Legal Name) : Chi-Hui Lai		
Signature:	Date:	
NAME OF INVENTOR (Full Legal Name) : Shu-Rong Chun		*********
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NAME OF INVENTOR (Full Legal Name) : Chung-Shi Liu		
Signature:	Date:	
NAME OF INVENTOR (Full Legal Name) : Chen-Hua Yu		
Signature:	Date:	
NAME OF INVENTOR (Full Legal Name): Yu-Chia Lai		
Signature:	Date:	

PATENT REEL: 057819 FRAME: 0193